

JUL 17 2003

PATENT & TRADEMARK OFFICE

PATENT APPLICATION

IN THE U.S. PATENT AND TRADEMARK OFFICE

July 14, 2003

Applicant(s): Chikao IKENAGA et al.

For: FRAME FOR SEMICONDUCTOR PACKAGE INCLUDING PLURAL LEAD  
FRAMES HAVING THIN PARTS OR HOLLOWES ADJACENT THE  
TERMINAL ROOTS

Serial No.: 09/850 213

Group: 2826

Confirmation No.: 9610

Filed: May 7, 2001

Examiner: P. Greene

International Application No.: N/A

International Filing Date: N/A

Atty. Docket No.: OPS Case 533

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

RESPONSE

Sir:

In response to the Office Action dated March 13, 2003,  
please amend the above-identified application as follows:

(Please see following pages.)

CERTIFICATE OF MAILING

I hereby certify that this correspondence is being  
deposited with the United States Postal Service with  
sufficient postage as first class mail in an envelope  
addressed to: Commissioner for Patents, P.O. Box 1450,  
Alexandria, VA 22313-1450, on July 14, 2003.

*Liane L. Churney*  
Liane L. Churney

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amendment  
9/5/03*

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